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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



Dual P-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY		
V_{DS} (V)	$R_{DS(on)}$ (Ω)	I_D (A)
- 20	0.024 at $V_{GS} = - 4.5$ V	- 5.4
	0.030 at $V_{GS} = - 2.5$ V	- 4.8
	0.042 at $V_{GS} = - 1.8$ V	- 4.0

FEATURES

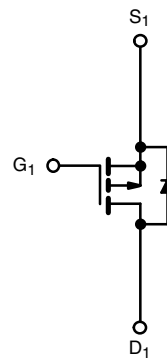
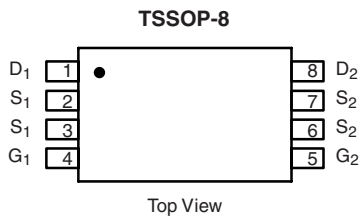
- Halogen-free
- TrenchFET[®] Power MOSFET



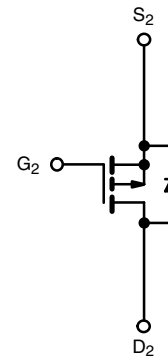
RoHS
COMPLIANT

APPLICATIONS

- Load Switch
- Battery Switch



P-Channel MOSFET



P-Channel MOSFET

Ordering Information: Si6983DQ-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS $T_A = 25$ °C, unless otherwise noted				
Parameter	Symbol	10 s	Steady State	Unit
Drain-Source Voltage	V_{DS}	- 20		V
Gate-Source Voltage	V_{GS}	± 8		
Continuous Drain Current ($T_J = 150$ °C) ^a	$T_A = 25$ °C	- 5.4	- 4.6	A
	$T_A = 70$ °C	- 4.3	- 3.7	
Pulsed Drain Current (10 μ s Pulse Width)	I_{DM}	- 30		
Continuous Source Current (Diode Conduction) ^a	I_S	- 1.0	- 0.7	
Maximum Power Dissipation ^a	$T_A = 25$ °C	1.14	0.83	W
	$T_A = 70$ °C	0.73	0.53	
Operating Junction and Storage Temperature Range	T_J, T_{stg}	- 55 to 150		°C

THERMAL RESISTANCE RATINGS				
Parameter	Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^a	$t \leq 10$ s	86	110	°C/W
	Steady State	124	150	
Maximum Junction-to-Foot (Drain)	Steady State	52	65	

Notes:

a. Surface Mounted on 1" x 1" FR4 board.



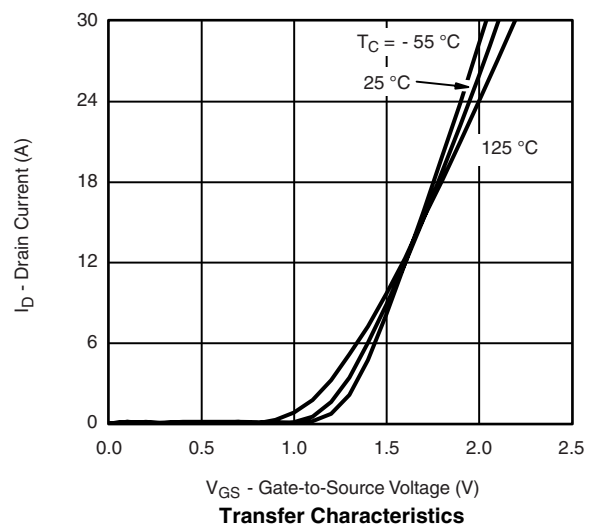
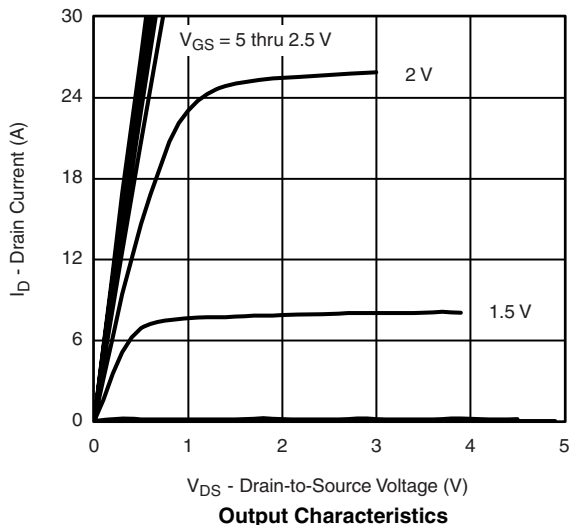
SPECIFICATIONS $T_J = 25\text{ }^\circ\text{C}$, unless otherwise noted						
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Static						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -400\text{ }\mu\text{A}$	-0.40		-1.0	V
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0\text{ V}, V_{GS} = \pm 8\text{ V}$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = -20\text{ V}, V_{GS} = 0\text{ V}$			-1	μA
		$V_{DS} = -20\text{ V}, V_{GS} = 0\text{ V}, T_J = 70\text{ }^\circ\text{C}$			-25	
On-State Drain Current ^a	$I_{D(on)}$	$V_{DS} = -5\text{ V}, V_{GS} = -4.5\text{ V}$	-20			A
Drain-Source On-State Resistance ^a	$R_{DS(on)}$	$V_{GS} = -4.5\text{ V}, I_D = -5.4\text{ A}$		0.019	0.024	Ω
		$V_{GS} = -2.5\text{ V}, I_D = -4.8\text{ A}$		0.024	0.030	
		$V_{GS} = -1.8\text{ V}, I_D = -4.0\text{ A}$		0.033	0.042	
Forward Transconductance ^a	g_{fs}	$V_{DS} = -5\text{ V}, I_D = -5.4\text{ A}$		25		S
Diode Forward Voltage ^a	V_{SD}	$I_S = -1.0\text{ A}, V_{GS} = 0\text{ V}$		-0.63	-1.1	V
Dynamic^b						
Total Gate Charge	Q_g	$V_{DS} = -10\text{ V}, V_{GS} = -4.5\text{ V}, I_D = -5.4\text{ A}$		20	30	nC
Gate-Source Charge	Q_{gs}		3.0			
Gate-Drain Charge	Q_{gd}		4.5			
Gate Resistance	R_g	$f = 1.0\text{ MHz}$		4.5		Ω
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = -6\text{ V}, R_L = 6\text{ }\Omega$ $I_D \cong -1\text{ A}, V_{GEN} = -4.5\text{ V}, R_G = 6\text{ }\Omega$		40	60	ns
Rise Time	t_r		55	85		
Turn-Off Delay Time	$t_{d(off)}$		135	200		
Fall Time	t_f		52	80		
Source-Drain Reverse Recovery Time	t_{rr}	$I_F = -1.0\text{ A}, di/dt = 100\text{ A}/\mu\text{s}$		40	70	

Notes:

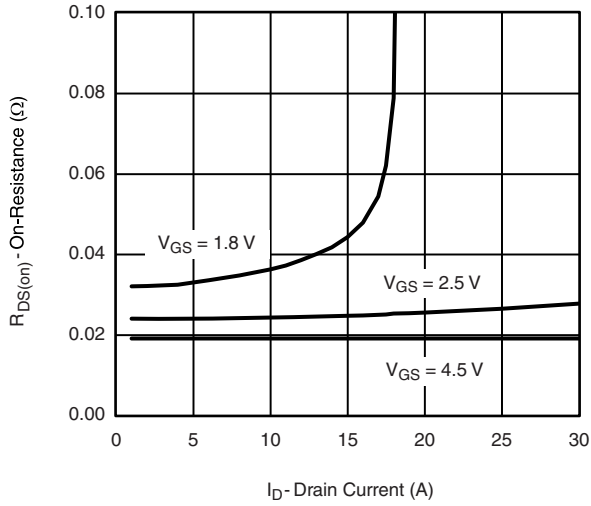
- a. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

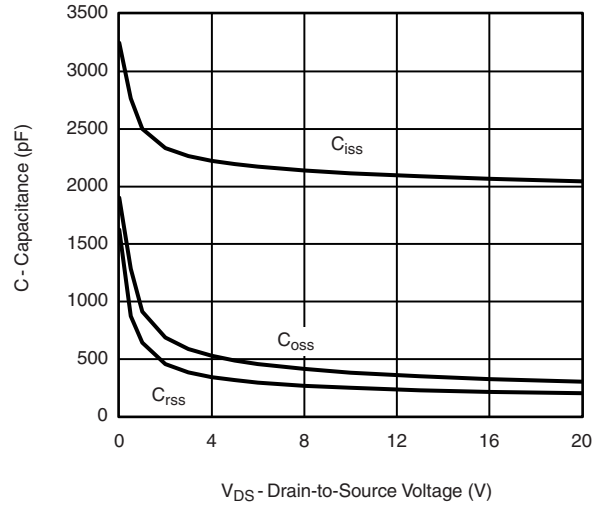
TYPICAL CHARACTERISTICS $25\text{ }^\circ\text{C}$, unless otherwise noted



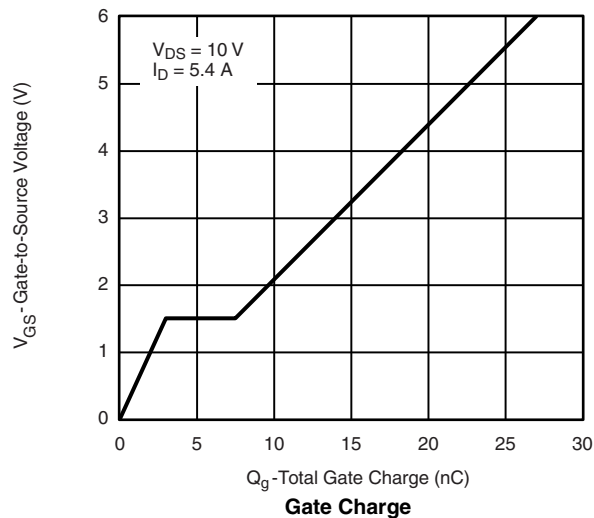
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



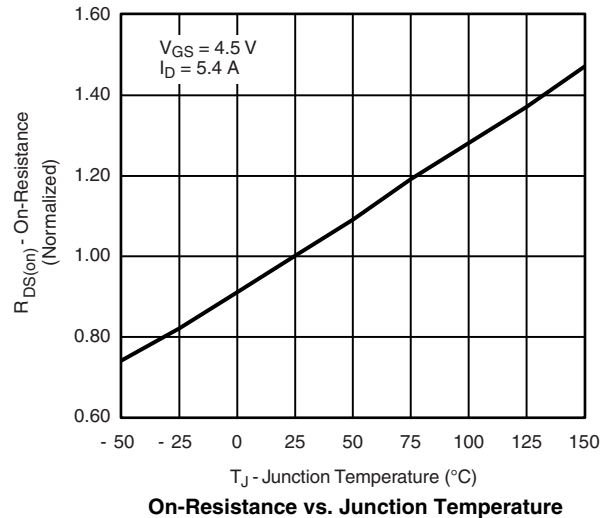
On-Resistance vs. Drain Current



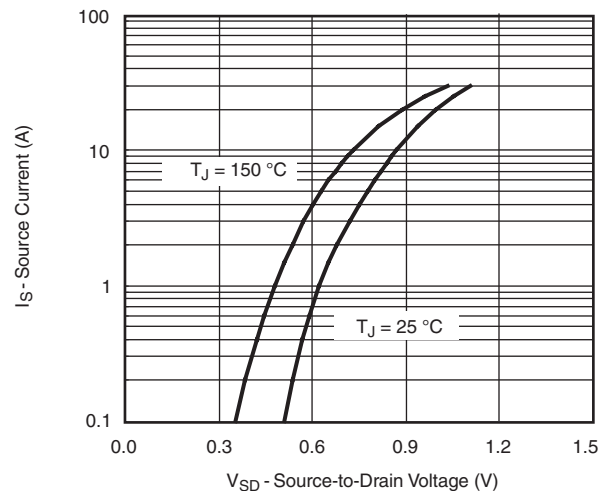
Capacitance



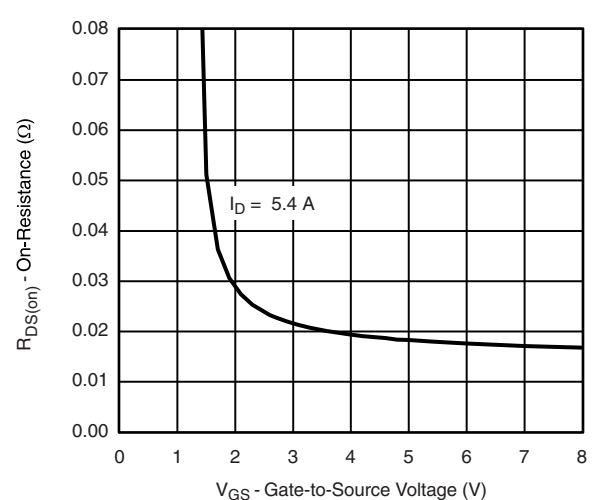
Gate Charge



On-Resistance vs. Junction Temperature

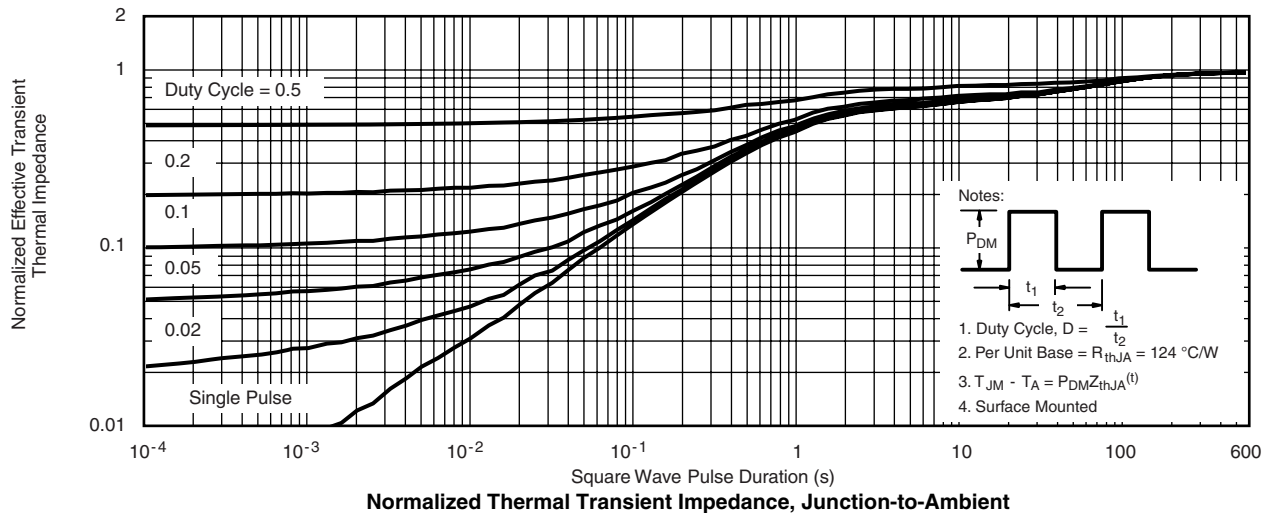
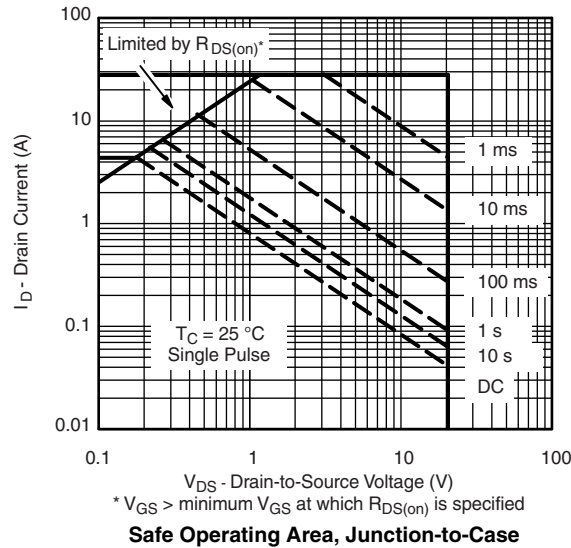
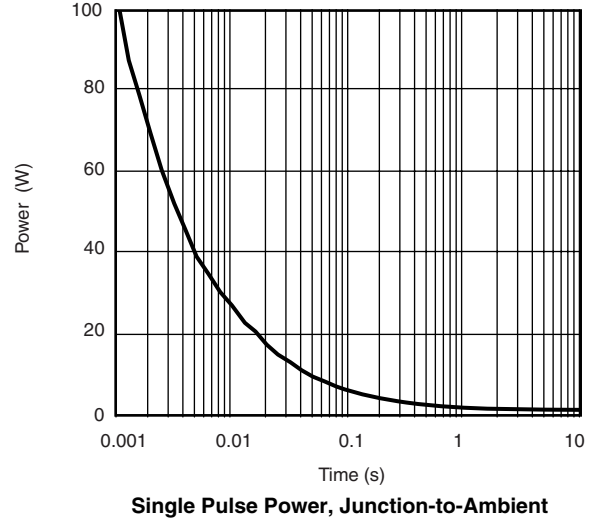
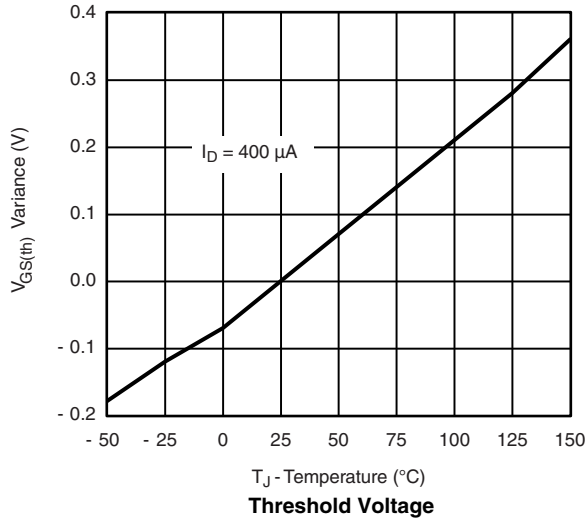


Source-Drain Diode Forward Voltage



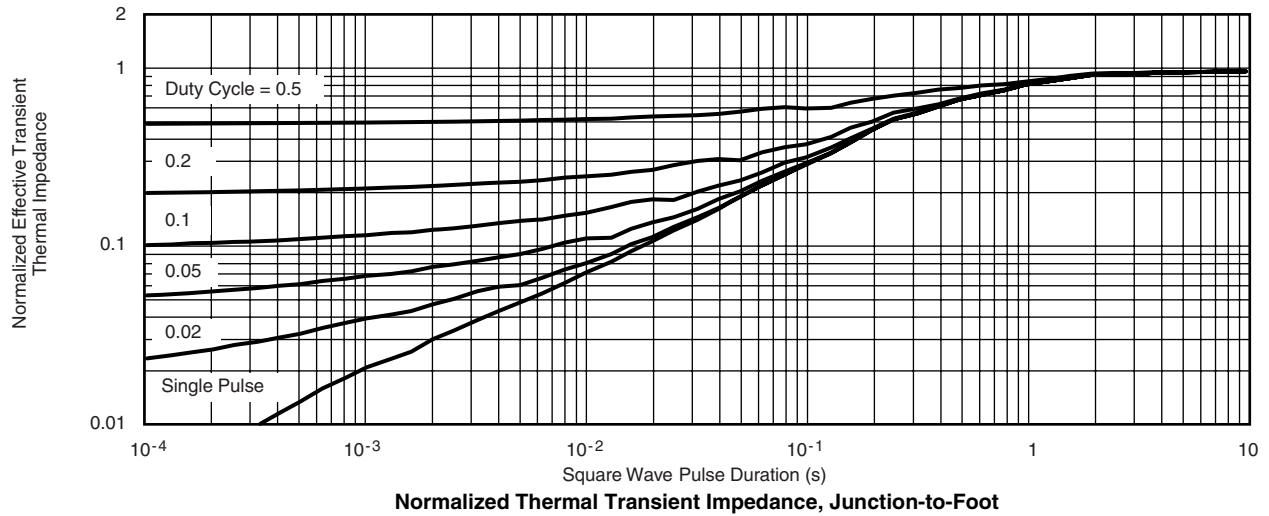
On-Resistance vs. Gate-to-Source Voltage

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



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